

74AUP1G885

Low-power dual function gate

Rev. 01.00 — 26 January 2006

Preliminary data sheet

1. General description

The 74AUP1G885 is a high-performance, low-power, low-voltage, Si-gate CMOS device, superior to most advanced CMOS compatible TTL families.

Schmitt-trigger action at all inputs makes the circuit tolerant to slower input rise and fall times across the entire V_{CC} range from 0.8 V to 3.6 V.

This device ensures a very low static and dynamic power consumption across the entire V_{CC} range from 0.8 V to 3.6 V.

This device is fully specified for partial Power-down applications using I_{OFF} . The I_{OFF} circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

The 74AUP1G885 provides two functions in one device. The output state of the outputs (1Y, 2Y) is determined by the inputs (A, B and C). The output 1Y provides the boolean function: $1Y = A \times C$. The output 2Y provides the boolean function: $2Y = \bar{A} \times B + A \times \bar{C}$

2. Features

- Wide supply voltage range from 0.8 V to 3.6 V
- High noise immunity
- Complies with JEDEC standards:
 - ◆ JESD8-12 (0.8 V to 1.3 V)
 - ◆ JESD8-11 (0.9 V to 1.65 V)
 - ◆ JESD8-7 (1.2 V to 1.95 V)
 - ◆ JESD8-5 (1.8 V to 2.7 V)
 - ◆ JESD8-B (2.7 V to 3.6 V)
- ESD protection:
 - ◆ HBM JESD22-A114-C Class 3A exceeds 4000 V
 - ◆ MM JESD22-A115-A exceeds 200 V
 - ◆ CDM JESD22-C101-C exceeds 1000 V
- Low static power consumption; $I_{CC} = 0.9 \mu\text{A}$ (maximum)
- Latch-up performance exceeds 100 mA per JESD 78 Class II
- Inputs accept voltages up to 3.6 V
- Low noise overshoot and undershoot < 10 % of V_{CC}
- I_{OFF} circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from $-40 \text{ }^\circ\text{C}$ to $+85 \text{ }^\circ\text{C}$ and $-40 \text{ }^\circ\text{C}$ to $+125 \text{ }^\circ\text{C}$

PHILIPS

3. Quick reference data

Table 1: Quick reference data

$GND = 0\text{ V}$; $T_{amb} = 25\text{ °C}$; $t_r = t_f \leq 3\text{ ns}$.

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit | |
|-----------------------|--|---|---------|------|------|------|----|
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 0.8\text{ V}$ | - | 17.3 | - | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 1.1 | 5.2 | 9.7 | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 1.2 | 3.7 | 5.9 | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 1.1 | 3.0 | 4.8 | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.1 | 2.4 | 3.6 | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.1 | 2.1 | 3.1 | ns | |
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 0.8\text{ V}$ | - | 21.5 | - | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 1.7 | 6.0 | 12.7 | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 1.7 | 4.2 | 7.2 | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 1.4 | 3.3 | 5.8 | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.2 | 2.6 | 4.1 | ns | |
| | | $C_L = 5\text{ pF}$; $R_L = 1\text{ M}\Omega$; $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.1 | 2.3 | 3.5 | ns | |
| C_I | input capacitance | | - | 0.8 | - | pF | |
| C_{PD} | power dissipation capacitance | $V_{CC} = 1.8\text{ V}$; $f = 1\text{ MHz}$ | [1] [2] | - | 3.1 | - | pF |
| | | $V_{CC} = 3.3\text{ V}$; $f = 1\text{ MHz}$ | [1] [2] | - | 4.1 | - | pF |

[1] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

C_L = output load capacitance in pF;

V_{CC} = supply voltage in V;

N = number of inputs switching;

$\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

[2] The condition is $V_I = GND$ to V_{CC} .

4. Ordering information

Table 2: Ordering information

| Type number | Package | | | Version |
|--------------|-------------------|--------|---|----------|
| | Temperature range | Name | Description | |
| 74AUP1G885DC | -40 °C to +125 °C | VSSOP8 | plastic very thin shrink small outline package; 8 leads; body width 2.3 mm | SOT765-1 |
| 74AUP1G885GT | -40 °C to +125 °C | XSON8 | plastic extremely thin small outline package; no leads; 8 terminals; body 1 × 1.95 × 0.5 mm | SOT833-1 |

5. Marking

Table 3: Marking

| Type number | Marking code |
|--------------|--------------|
| 74AUP1G885DC | pS8 |
| 74AUP1G885GT | pS8 |

6. Functional diagram

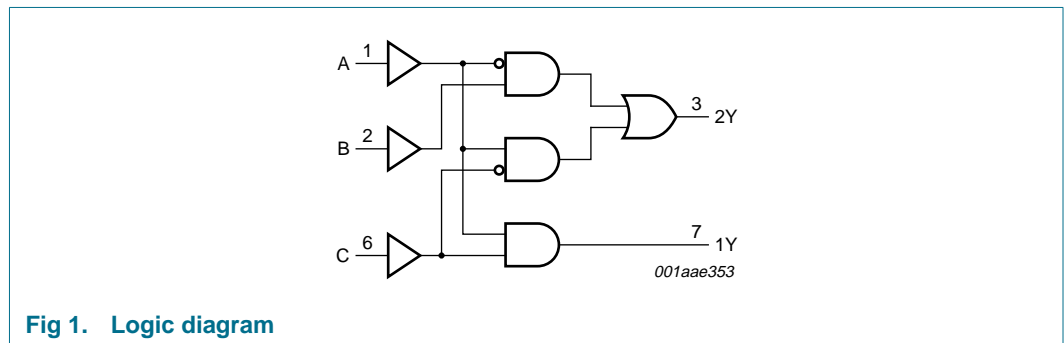
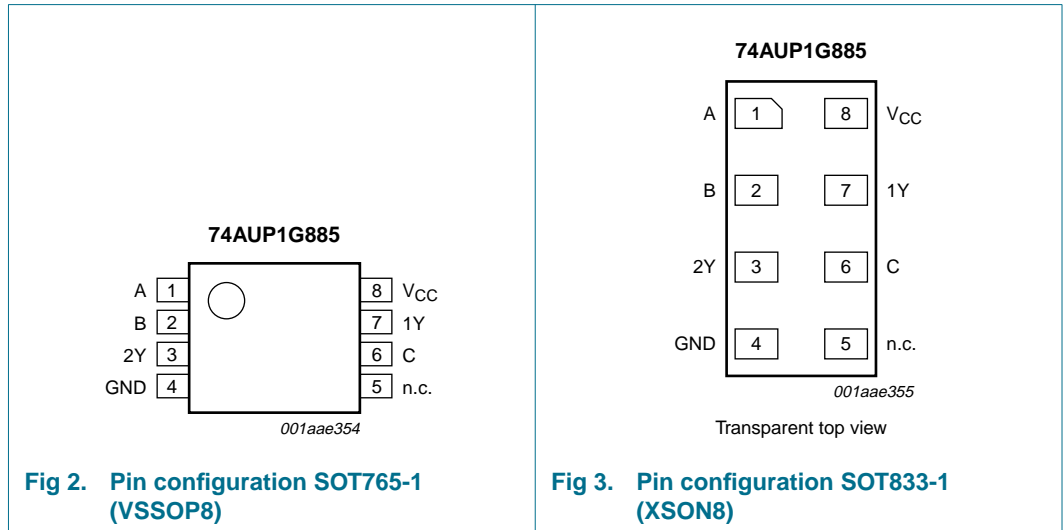


Fig 1. Logic diagram

7. Pinning information

7.1 Pinning



7.2 Pin description

Table 4: Pin description

| Symbol | Pin | Description |
|-----------------|-----|----------------|
| A | 1 | data input A |
| B | 2 | data input B |
| 2Y | 3 | data output 2Y |
| GND | 4 | ground (0 V) |
| n.c. | 5 | not connected |
| C | 6 | data input C |
| 1Y | 7 | data output 1Y |
| V _{CC} | 8 | supply voltage |

8. Functional description

8.1 Function table

Table 5: Function table ^[1]

| Input | | | Output | |
|-------|---|---|--------|----|
| A | B | C | 1Y | 2Y |
| L | L | L | L | L |
| H | L | L | L | H |
| L | H | L | L | H |
| H | H | L | L | H |
| L | L | H | L | L |
| H | L | H | H | L |
| L | H | H | L | H |
| H | H | H | H | L |

[1] H = HIGH voltage level;
L = LOW voltage level.

9. Limiting values

Table 6: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|-----------|--------------------------|-------------------------------|---------------------|----------------|------|
| V_{CC} | supply voltage | | -0.5 | +4.6 | V |
| I_{IK} | input clamping current | $V_I < 0$ V | - | -50 | mA |
| V_I | input voltage | | ^[1] -0.5 | +4.6 | V |
| I_{OK} | output clamping current | $V_O < 0$ V | - | -50 | mA |
| V_O | output voltage | active mode | ^[1] -0.5 | $V_{CC} + 0.5$ | V |
| | | Power-down mode | ^[1] -0.5 | +4.6 | V |
| I_O | output current | $V_O = 0$ V to V_{CC} | - | ± 20 | mA |
| I_{CC} | quiescent supply current | | - | +50 | mA |
| I_{GND} | ground current | | - | -50 | mA |
| T_{stg} | storage temperature | | -65 | +150 | °C |
| P_{tot} | total power dissipation | $T_{amb} = -40$ °C to +125 °C | ^[2] - | 300 | mW |

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For VSSOP8 packages: above 110 °C the value of P_{tot} derates linearly with 8.0 mW/K.
For XSON8 packages: above 45 °C the value of P_{tot} derates linearly with 2.4 mW/K.

10. Recommended operating conditions

Table 7: Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|-------------------------------------|---------------------------------|-----|----------|------|
| V_{CC} | supply voltage | | 0.8 | 3.6 | V |
| V_I | input voltage | | 0 | 3.6 | V |
| V_O | output voltage | active mode | 0 | V_{CC} | V |
| | | Power-down mode; $V_{CC} = 0$ V | 0 | 3.6 | V |
| T_{amb} | ambient temperature | | -40 | +125 | °C |
| $\Delta t/\Delta V$ | input transition rise and fall rate | $V_{CC} = 0.8$ V to 3.6 V | 0 | 200 | ns/V |

11. Static characteristics

Table 8: Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------------------------|---------------------------|--|----------------------|-----|----------------------|------|
| $T_{amb} = 25$ °C | | | | | | |
| V_{IH} | HIGH-state input voltage | $V_{CC} = 0.8$ V | $0.70 \times V_{CC}$ | - | - | V |
| | | $V_{CC} = 0.9$ V to 1.95 V | $0.65 \times V_{CC}$ | - | - | V |
| | | $V_{CC} = 2.3$ V to 2.7 V | 1.6 | - | - | V |
| | | $V_{CC} = 3.0$ V to 3.6 V | 2.0 | - | - | V |
| V_{IL} | LOW-state input voltage | $V_{CC} = 0.8$ V | - | - | $0.30 \times V_{CC}$ | V |
| | | $V_{CC} = 0.9$ V to 1.95 V | - | - | $0.35 \times V_{CC}$ | V |
| | | $V_{CC} = 2.3$ V to 2.7 V | - | - | 0.7 | V |
| | | $V_{CC} = 3.0$ V to 3.6 V | - | - | 0.9 | V |
| V_{OH} | HIGH-state output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -20$ μ A; $V_{CC} = 0.8$ V to 3.6 V | $V_{CC} - 0.1$ | - | - | V |
| | | $I_O = -1.1$ mA; $V_{CC} = 1.1$ V | $0.75 \times V_{CC}$ | - | - | V |
| | | $I_O = -1.7$ mA; $V_{CC} = 1.4$ V | 1.11 | - | - | V |
| | | $I_O = -1.9$ mA; $V_{CC} = 1.65$ V | 1.32 | - | - | V |
| | | $I_O = -2.3$ mA; $V_{CC} = 2.3$ V | 2.05 | - | - | V |
| | | $I_O = -3.1$ mA; $V_{CC} = 2.3$ V | 1.9 | - | - | V |
| | | $I_O = -2.7$ mA; $V_{CC} = 3.0$ V | 2.72 | - | - | V |
| $I_O = -4.0$ mA; $V_{CC} = 3.0$ V | 2.6 | - | - | V | | |

Table 8: Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|--------------------------------------|--|------------------------|-----|------------------------|------|
| V _{OL} | LOW-state output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 20 μA; V _{CC} = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | - | - | 0.3 × V _{CC} | V |
| | | I _O = 1.7 mA; V _{CC} = 1.4 V | - | - | 0.31 | V |
| | | I _O = 1.9 mA; V _{CC} = 1.65 V | - | - | 0.31 | V |
| | | I _O = 2.3 mA; V _{CC} = 2.3 V | - | - | 0.31 | V |
| | | I _O = 3.1 mA; V _{CC} = 2.3 V | - | - | 0.44 | V |
| | | I _O = 2.7 mA; V _{CC} = 3.0 V | - | - | 0.31 | V |
| | | I _O = 4.0 mA; V _{CC} = 3.0 V | - | - | 0.44 | V |
| I _I | input leakage current | V _I = GND to 3.6 V; V _{CC} = 0 V to 3.6 V | - | - | ±0.1 | μA |
| I _{OFF} | power-off leakage current | V _I or V _O = 0 V to 3.6 V; V _{CC} = 0 V | - | - | ±0.2 | μA |
| ΔI _{OFF} | additional power-off leakage current | V _I or V _O = 0 V to 3.6 V; V _{CC} = 0 V to 0.2 V | - | - | ±0.2 | μA |
| I _{CC} | quiescent supply current | V _I = GND or V _{CC} ; I _O = 0 A; V _{CC} = 0.8 V to 3.6 V | - | - | 0.5 | μA |
| ΔI _{CC} | additional quiescent supply current | V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 3.3 V | [1] | - | 40 | μA |
| C _I | input capacitance | V _{CC} = 0 V to 3.6 V; V _I = GND or V _{CC} | - | 0.8 | - | pF |
| C _O | output capacitance | V _O = GND; V _{CC} = 0 V | - | 1.7 | - | pF |
| T_{amb} = -40 °C to +85 °C | | | | | | |
| V _{IH} | HIGH-state input voltage | V _{CC} = 0.8 V | 0.70 × V _{CC} | - | - | V |
| | | V _{CC} = 0.9 V to 1.95 V | 0.65 × V _{CC} | - | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | V _{CC} = 3.0 V to 3.6 V | 2.0 | - | - | V |
| V _{IL} | LOW-state input voltage | V _{CC} = 0.8 V | - | - | 0.30 × V _{CC} | V |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | 0.35 × V _{CC} | V |
| | | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | V _{CC} = 3.0 V to 3.6 V | - | - | 0.9 | V |
| V _{OH} | HIGH-state output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -20 μA; V _{CC} = 0.8 V to 3.6 V | V _{CC} - 0.1 | - | - | V |
| | | I _O = -1.1 mA; V _{CC} = 1.1 V | 0.7 × V _{CC} | - | - | V |
| | | I _O = -1.7 mA; V _{CC} = 1.4 V | 1.03 | - | - | V |
| | | I _O = -1.9 mA; V _{CC} = 1.65 V | 1.30 | - | - | V |
| | | I _O = -2.3 mA; V _{CC} = 2.3 V | 1.97 | - | - | V |
| | | I _O = -3.1 mA; V _{CC} = 2.3 V | 1.85 | - | - | V |
| | | I _O = -2.7 mA; V _{CC} = 3.0 V | 2.67 | - | - | V |
| | | I _O = -4.0 mA; V _{CC} = 3.0 V | 2.55 | - | - | V |

Table 8: Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|--|--------------------------------------|---|------------------------|-----|------------------------|------|
| V _{OL} | LOW-state output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 20 μA; V _{CC} = 0.8 V to 3.6 V | - | - | 0.1 | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | - | - | 0.3 × V _{CC} | V |
| | | I _O = 1.7 mA; V _{CC} = 1.4 V | - | - | 0.37 | V |
| | | I _O = 1.9 mA; V _{CC} = 1.65 V | - | - | 0.35 | V |
| | | I _O = 2.3 mA; V _{CC} = 2.3 V | - | - | 0.33 | V |
| | | I _O = 3.1 mA; V _{CC} = 2.3 V | - | - | 0.45 | V |
| | | I _O = 2.7 mA; V _{CC} = 3.0 V | - | - | 0.33 | V |
| | | I _O = 4.0 mA; V _{CC} = 3.0 V | - | - | 0.45 | V |
| I _I | input leakage current | V _I = GND to 3.6 V; V _{CC} = 0 V to 3.6 V | - | - | ±0.5 | μA |
| I _{OFF} | power-off leakage current | V _I or V _O = 0 V to 3.6 V; V _{CC} = 0 V | - | - | ±0.5 | μA |
| ΔI _{OFF} | additional power-off leakage current | V _I or V _O = 0 V to 3.6 V; V _{CC} = 0 V to 0.2 V | - | - | ±0.6 | μA |
| I _{CC} | quiescent supply current | V _I = GND or V _{CC} ; I _O = 0 A; V _{CC} = 0.8 V to 3.6 V | - | - | 0.9 | μA |
| ΔI _{CC} | additional quiescent supply current | V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 3.3 V | [1] | - | 50 | μA |
| T_{amb} = -40 °C to +125 °C | | | | | | |
| V _{IH} | HIGH-state input voltage | V _{CC} = 0.8 V | 0.75 × V _{CC} | - | - | V |
| | | V _{CC} = 0.9 V to 1.95 V | 0.70 × V _{CC} | - | - | V |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | - | - | V |
| | | V _{CC} = 3.0 V to 3.6 V | 2.0 | - | - | V |
| V _{IL} | LOW-state input voltage | V _{CC} = 0.8 V | - | - | 0.25 × V _{CC} | V |
| | | V _{CC} = 0.9 V to 1.95 V | - | - | 0.30 × V _{CC} | V |
| | | V _{CC} = 2.3 V to 2.7 V | - | - | 0.7 | V |
| | | V _{CC} = 3.0 V to 3.6 V | - | - | 0.9 | V |
| V _{OH} | HIGH-state output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = -20 μA; V _{CC} = 0.8 V to 3.6 V | V _{CC} - 0.11 | - | - | V |
| | | I _O = -1.1 mA; V _{CC} = 1.1 V | 0.6 × V _{CC} | - | - | V |
| | | I _O = -1.7 mA; V _{CC} = 1.4 V | 0.93 | - | - | V |
| | | I _O = -1.9 mA; V _{CC} = 1.65 V | 1.17 | - | - | V |
| | | I _O = -2.3 mA; V _{CC} = 2.3 V | 1.77 | - | - | V |
| | | I _O = -3.1 mA; V _{CC} = 2.3 V | 1.67 | - | - | V |
| | | I _O = -2.7 mA; V _{CC} = 3.0 V | 2.40 | - | - | V |
| | | I _O = -4.0 mA; V _{CC} = 3.0 V | 2.30 | - | - | V |

Table 8: Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|-------------------|--------------------------------------|--|-----|-----|------------------------|------|
| V _{OL} | LOW-state output voltage | V _I = V _{IH} or V _{IL} | | | | |
| | | I _O = 20 μA; V _{CC} = 0.8 V to 3.6 V | - | - | 0.11 | V |
| | | I _O = 1.1 mA; V _{CC} = 1.1 V | - | - | 0.33 × V _{CC} | V |
| | | I _O = 1.7 mA; V _{CC} = 1.4 V | - | - | 0.41 | V |
| | | I _O = 1.9 mA; V _{CC} = 1.65 V | - | - | 0.39 | V |
| | | I _O = 2.3 mA; V _{CC} = 2.3 V | - | - | 0.36 | V |
| | | I _O = 3.1 mA; V _{CC} = 2.3 V | - | - | 0.50 | V |
| | | I _O = 2.7 mA; V _{CC} = 3.0 V | - | - | 0.36 | V |
| | | I _O = 4.0 mA; V _{CC} = 3.0 V | - | - | 0.50 | V |
| I _I | input leakage current | V _I = GND to 3.6 V; V _{CC} = 0 V to 3.6 V | - | - | ±0.75 | μA |
| I _{OFF} | power-off leakage current | V _I or V _O = 0 V to 3.6 V; V _{CC} = 0 V | - | - | ±0.75 | μA |
| ΔI _{OFF} | additional power-off leakage current | V _I or V _O = 0 V to 3.6 V; V _{CC} = 0 V to 0.2 V | - | - | ±0.75 | μA |
| I _{CC} | quiescent supply current | V _I = GND or V _{CC} ; I _O = 0 A; V _{CC} = 0.8 V to 3.6 V | - | - | 1.4 | μA |
| ΔI _{CC} | additional quiescent supply current | V _I = V _{CC} - 0.6 V; I _O = 0 A; V _{CC} = 3.3 V | [1] | - | 75 | μA |

[1] One input at V_{CC} - 0.6 V, other input at V_{CC} or GND.

12. Dynamic characteristics

Table 9: Dynamic characteristics

Voltages are referenced to GND (ground = 0 V; for test circuit see [Figure 5](#))

| Symbol | Parameter | Conditions | Min | Typ [1] | Max | Unit |
|--|--|------------------------------------|-----|---------|------|------|
| T_{amb} = 25 °C; C_L = 5 pF | | | | | | |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | |
| | | V _{CC} = 0.8 V | - | 17.3 | - | ns |
| | | V _{CC} = 1.1 V to 1.3 V | 1.1 | 5.2 | 9.7 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 1.2 | 3.7 | 5.9 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.1 | 3.0 | 4.8 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.1 | 2.4 | 3.6 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.1 | 2.1 | 3.1 | ns |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | |
| | | V _{CC} = 0.8 V | - | 21.5 | - | ns |
| | | V _{CC} = 1.1 V to 1.3 V | 1.7 | 6.0 | 12.7 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 1.7 | 4.2 | 7.2 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.4 | 3.3 | 5.8 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.2 | 2.6 | 4.1 | ns |
| | | V _{CC} = 3.0 V to 3.6 V | 1.1 | 2.3 | 3.5 | ns |

Table 9: Dynamic characteristics ...continuedVoltages are referenced to GND (ground = 0 V; for test circuit see [Figure 5](#))

| Symbol | Parameter | Conditions | Min | Typ ^[1] | Max | Unit |
|---|--|---|-----|--------------------|------|------|
| $T_{amb} = 25\text{ }^{\circ}\text{C}$; $C_L = 10\text{ pF}$ | | | | | | |
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | |
| | | $V_{CC} = 0.8\text{ V}$ | - | 20.8 | - | ns |
| | | $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 1.2 | 6.1 | 11.4 | ns |
| | | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 1.4 | 4.3 | 7.2 | ns |
| | | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 1.4 | 3.6 | 5.7 | ns |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.4 | 2.9 | 4.2 | ns |
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | |
| | | $V_{CC} = 0.8\text{ V}$ | - | 25.0 | - | ns |
| | | $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 1.8 | 6.9 | 14.4 | ns |
| | | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 1.9 | 4.8 | 8.5 | ns |
| | | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 1.9 | 3.9 | 6.6 | ns |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.5 | 3.1 | 4.7 | ns |
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | |
| | | $V_{CC} = 0.8\text{ V}$ | - | 24.3 | - | ns |
| | | $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 1.3 | 6.9 | 13.0 | ns |
| | | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 1.7 | 4.9 | 8.0 | ns |
| | | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 1.5 | 4.1 | 6.4 | ns |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.7 | 3.4 | 5.0 | ns |
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | |
| | | $V_{CC} = 0.8\text{ V}$ | - | 28.5 | - | ns |
| | | $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 2.1 | 7.7 | 16.0 | ns |
| | | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 2.2 | 5.4 | 9.4 | ns |
| | | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 2.0 | 4.4 | 7.4 | ns |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.8 | 3.6 | 5.5 | ns |
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | |
| | | $V_{CC} = 0.8\text{ V}$ | - | 34.7 | - | ns |
| | | $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 2.4 | 9.2 | 17.7 | ns |
| | | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 2.5 | 6.5 | 10.6 | ns |
| | | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 2.5 | 5.4 | 8.5 | ns |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 2.6 | 4.5 | 6.4 | ns |
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | |
| | | $V_{CC} = 0.8\text{ V}$ | - | 34.7 | - | ns |
| | | $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 2.4 | 9.2 | 17.7 | ns |
| | | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 2.5 | 6.5 | 10.6 | ns |
| | | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 2.5 | 5.4 | 8.5 | ns |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 2.6 | 4.5 | 6.4 | ns |
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | |
| | | $V_{CC} = 0.8\text{ V}$ | - | 34.7 | - | ns |
| | | $V_{CC} = 1.1\text{ V to }1.3\text{ V}$ | 2.4 | 9.2 | 17.7 | ns |
| | | $V_{CC} = 1.4\text{ V to }1.6\text{ V}$ | 2.5 | 6.5 | 10.6 | ns |
| | | $V_{CC} = 1.65\text{ V to }1.95\text{ V}$ | 2.5 | 5.4 | 8.5 | ns |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 2.6 | 4.5 | 6.4 | ns |

Table 9: Dynamic characteristics ...continuedVoltages are referenced to GND (ground = 0 V; for test circuit see [Figure 5](#))

| Symbol | Parameter | Conditions | Min | Typ [1] | Max | Unit |
|---|--|--|-----|---------|------|------|
| t_{PHL} , t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | - | 38.9 | - | ns |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | 2.6 | 10.0 | 20.5 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | 2.6 | 6.9 | 11.9 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 2.7 | 5.7 | 9.5 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 2.5 | 4.7 | 6.9 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 2.4 | 4.4 | 6.1 | ns |
| $T_{amb} = 25 \text{ }^\circ\text{C}$ | | | | | | |
| C_{PD} | power dissipation capacitance | $f = 1 \text{ MHz}$ | | | | |
| | | [2] [3] | | | | |
| | | $V_{CC} = 0.8 \text{ V}$ | - | 2.7 | - | pF |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | - | 2.9 | - | pF |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | - | 3.0 | - | pF |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | - | 3.1 | - | pF |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | - | 3.5 | - | pF |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | - | 4.1 | - | pF |

[1] All typical values are measured at nominal V_{CC} .[2] C_{PD} is used to determine the dynamic power dissipation (P_D in μW). $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz; C_L = output load capacitance in pF; V_{CC} = supply voltage in V; N = number of inputs switching; $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.[3] The condition is $V_I = \text{GND to } V_{CC}$.

Table 10: Dynamic characteristics

Voltages are referenced to GND (ground = 0 V; for test circuit see [Figure 5](#))

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|-------------------------------------|--|------------------------------------|------------------|------|-------------------|------|------|
| | | | Min | Max | Min | Max | |
| C_L = 5 pF | | | | | | | |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | | |
| | | V _{CC} = 1.1 V to 1.3 V | 0.9 | 12.8 | 0.9 | 14.2 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 1.0 | 7.8 | 1.0 | 8.6 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 0.9 | 6.2 | 0.9 | 6.9 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.0 | 4.1 | 1.0 | 4.5 | ns |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | | |
| | | V _{CC} = 1.1 V to 1.3 V | 1.4 | 12.8 | 1.4 | 14.2 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 1.4 | 7.8 | 1.4 | 8.7 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.2 | 6.5 | 1.2 | 7.2 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.0 | 4.7 | 1.0 | 5.2 | ns |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | | |
| | | V _{CC} = 1.1 V to 1.3 V | 1.7 | 14.6 | 1.7 | 16.1 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 1.5 | 9.1 | 1.5 | 10.1 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.7 | 7.2 | 1.7 | 8.0 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.3 | 5.4 | 1.3 | 5.9 | ns |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | | |
| | | V _{CC} = 1.1 V to 1.3 V | 1.3 | 4.6 | 1.3 | 5.1 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 1.3 | 4.6 | 1.3 | 5.1 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.4 | 7.6 | 1.4 | 8.4 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | 5.4 | 1.6 | 6.0 | ns |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | | |
| | | V _{CC} = 1.1 V to 1.3 V | 1.2 | 16.2 | 1.2 | 17.9 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 1.4 | 9.7 | 1.4 | 10.8 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.4 | 7.6 | 1.4 | 8.4 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | 5.4 | 1.6 | 6.0 | ns |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | | |
| | | V _{CC} = 1.1 V to 1.3 V | 1.9 | 16.3 | 1.9 | 18.0 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 2.4 | 10.3 | 2.4 | 11.4 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.8 | 8.2 | 1.8 | 9.1 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | 6.0 | 1.6 | 6.7 | ns |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | | |
| | | V _{CC} = 1.1 V to 1.3 V | 1.5 | 5.2 | 1.5 | 5.8 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 1.5 | 5.2 | 1.5 | 5.8 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.8 | 8.2 | 1.8 | 9.1 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | 6.0 | 1.6 | 6.7 | ns |
| t _{PHL} , t _{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | | |
| | | V _{CC} = 1.1 V to 1.3 V | 1.9 | 16.3 | 1.9 | 18.0 | ns |
| | | V _{CC} = 1.4 V to 1.6 V | 2.4 | 10.3 | 2.4 | 11.4 | ns |
| | | V _{CC} = 1.65 V to 1.95 V | 1.8 | 8.2 | 1.8 | 9.1 | ns |
| | | V _{CC} = 2.3 V to 2.7 V | 1.6 | 6.0 | 1.6 | 6.7 | ns |

Table 10: Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V; for test circuit see [Figure 5](#))

| Symbol | Parameter | Conditions | -40 °C to +85 °C | | -40 °C to +125 °C | | Unit |
|---|--|--|------------------|------|-------------------|------|------|
| | | | Min | Max | Min | Max | |
| $C_L = 30 \text{ pF}$ | | | | | | | |
| t_{PHL}, t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, C to 1Y | see Figure 4 | | | | | |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | 2.3 | 20.9 | 2.3 | 23.0 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | 2.5 | 12.2 | 2.5 | 13.5 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 2.4 | 9.4 | 2.4 | 10.4 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 2.4 | 7.0 | 2.4 | 7.7 | ns |
| t_{PHL}, t_{PLH} | HIGH-to-LOW and LOW-to-HIGH propagation delay A, B to 2Y | see Figure 4 | | | | | |
| | | $V_{CC} = 1.1 \text{ V to } 1.3 \text{ V}$ | 2.6 | 21.5 | 2.6 | 23.7 | ns |
| | | $V_{CC} = 1.4 \text{ V to } 1.6 \text{ V}$ | 2.6 | 13.2 | 2.6 | 14.5 | ns |
| | | $V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$ | 2.7 | 10.5 | 2.7 | 11.6 | ns |
| | | $V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$ | 2.5 | 7.6 | 2.5 | 8.4 | ns |
| | | $V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$ | 2.4 | 7.1 | 2.4 | 7.9 | ns |

13. Waveforms

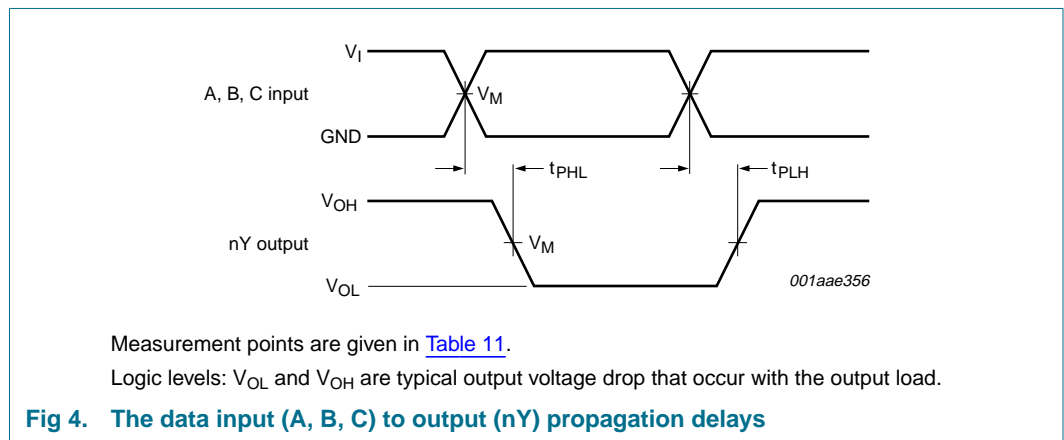


Table 11: Measurement points

| Supply voltage | Output | Input | | |
|----------------|---------------------|---------------------|----------|-----------------------|
| V_{CC} | V_M | V_M | V_I | $t_r = t_f$ |
| 0.8 V to 3.6 V | $0.5 \times V_{CC}$ | $0.5 \times V_{CC}$ | V_{CC} | $\leq 3.0 \text{ ns}$ |

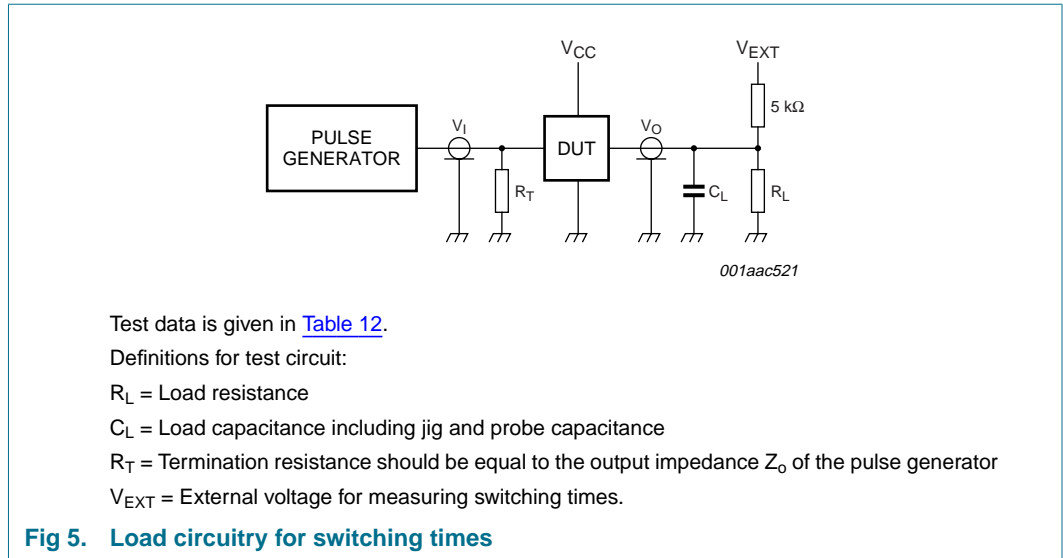


Fig 5. Load circuitry for switching times

Table 12: Test data

| Supply voltage | Load | | V_{EXT} | | |
|----------------|---------------------------------|--------------|--------------------|--------------------|--------------------|
| V_{CC} | C_L | R_L [1] | t_{PLH}, t_{PHL} | t_{PZH}, t_{PHZ} | t_{PZL}, t_{PLZ} |
| 0.8 V to 3.6 V | 5 pF, 10 pF, 15 pF and 30 pF | 5 kΩ or 1 MΩ | open | GND | $2 \times V_{CC}$ |

[1] For measuring enable and disable times $R_L = 5 \text{ k}\Omega$, for measuring propagation delays, setup and hold times and pulse width $R_L = 1 \text{ M}\Omega$.

14. Package outline

VSSOP8: plastic very thin shrink small outline package; 8 leads; body width 2.3 mm

SOT765-1

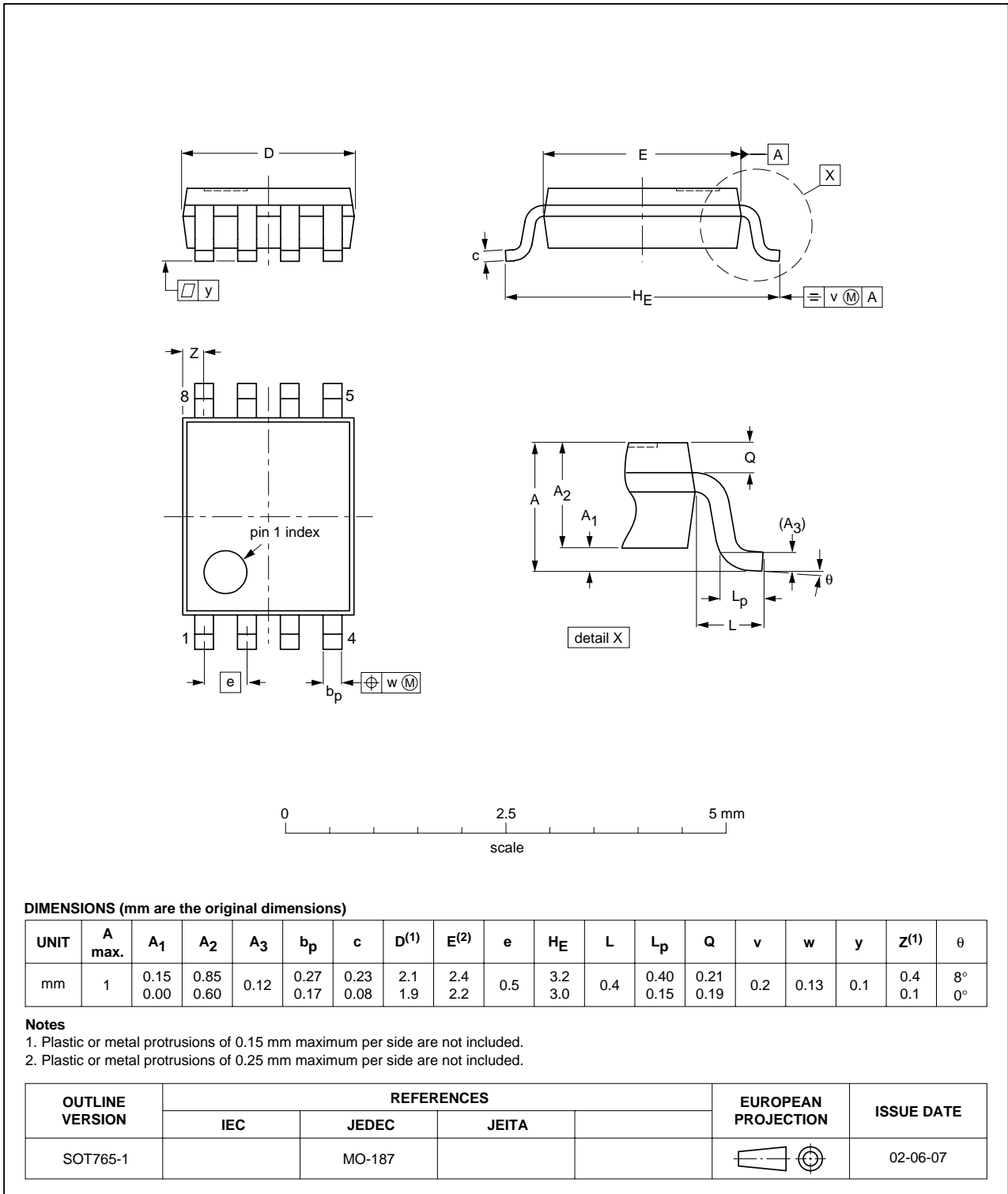


Fig 6. Package outline SOT765-1 (VSSOP8)

XSON8: plastic extremely thin small outline package; no leads; 8 terminals; body 1 x 1.95 x 0.5 mm

SOT833-1

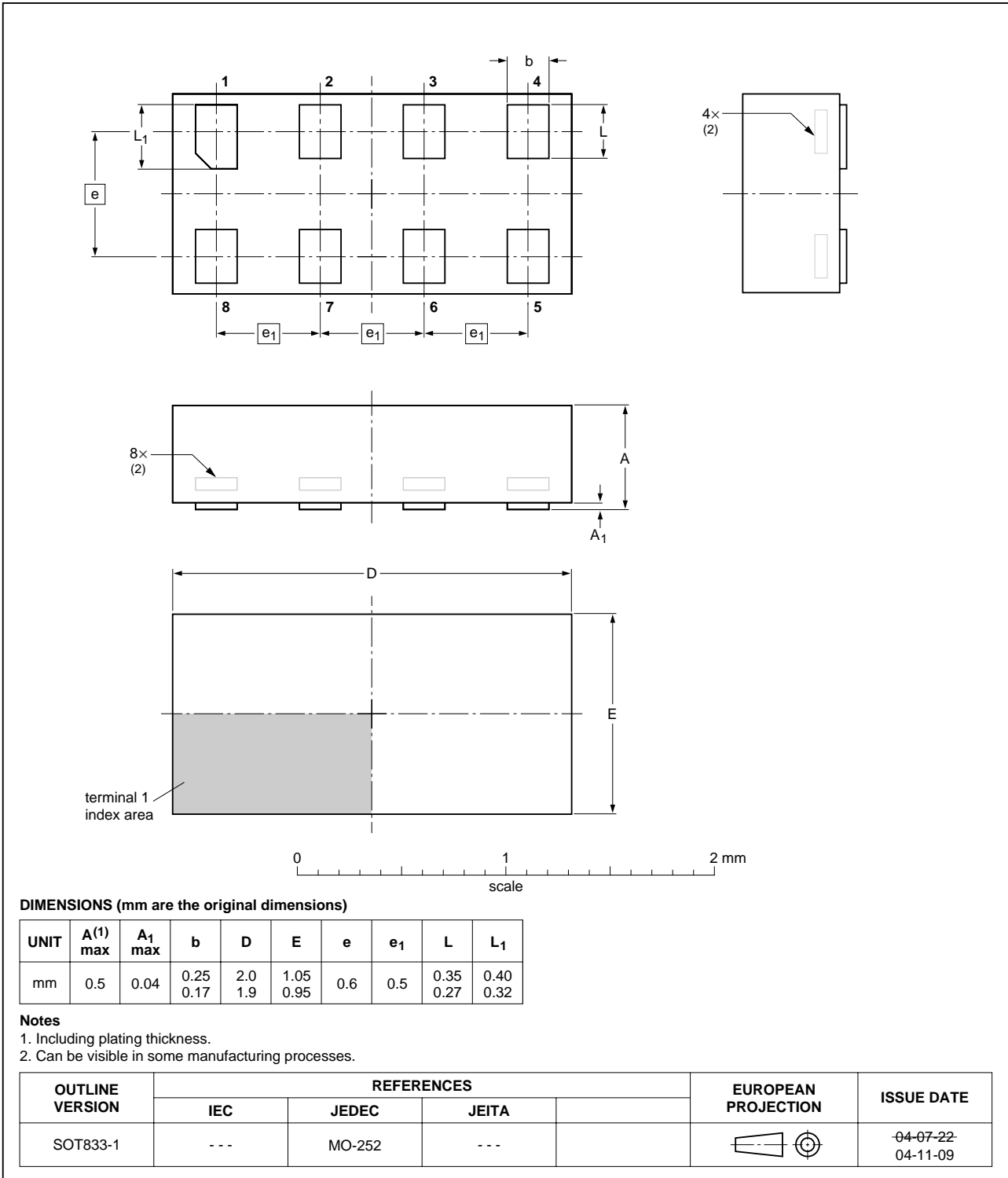


Fig 7. Package outline SOT833-1 (XSON8)

15. Abbreviations

Table 13: Abbreviations

| Acronym | Description |
|---------|---|
| CDM | Charged Device Model |
| CMOS | Complementary Metal Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| MM | Machine Model |
| TTL | Transistor Transistor Logic |

16. Revision history

Table 14: Revision history

| Document ID | Release date | Data sheet status | Change notice | Doc. number | Supersedes |
|--------------|--------------|------------------------|---------------|-------------|------------|
| 74AUP1G885_1 | <td> | Preliminary data sheet | - | - | - |

17. Data sheet status

| Level | Data sheet status ^[1] | Product status ^{[2] [3]} | Definition |
|-------|----------------------------------|-----------------------------------|--|
| I | Objective data | Development | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice. |
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[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

[3] For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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